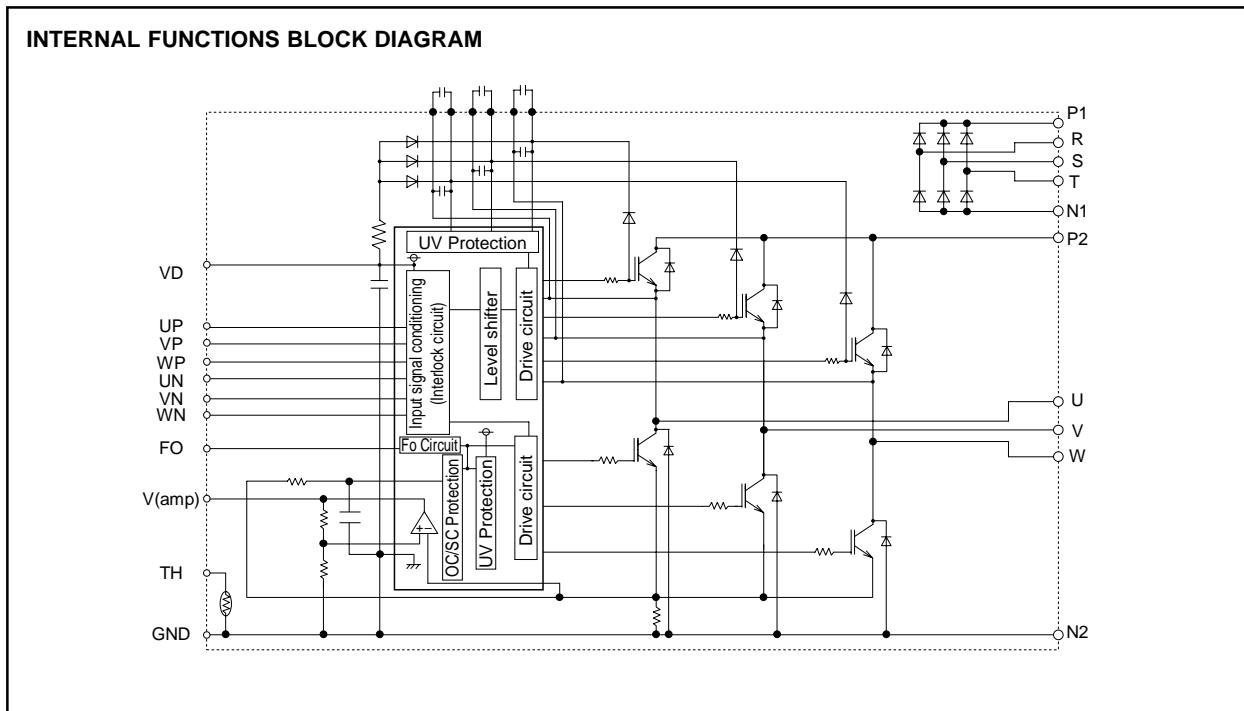




**PS12032**

FLAT-BASE TYPE  
INSULATED TYPE



(Fig. 2)

**MAXIMUM RATINGS** (Tj = 25°C)

**INVERTER PART**

Symbol	Item	Condition	Ratings	Unit
VCC	Supply voltage	Applied between P2-N2	900	V
VCC(surge)	Supply voltage (surge)	Applied between P2-N2, Surge-value	1000	V
VP or VN	Each IGBT collector-emitter static voltage	Applied between P2-U.V.W, U.V.W-N2	1200	V
VP(S) or VN(S)	Each IGBT collector-emitter switching voltage	Applied between P2-U.V.W, U.V.W-N2 (Pulse)	1200	V
±Ic(±Icp)	Each IGBT collector current	Tc = 25°C, "( )" means Ic peak value	±5 (±10)	A

**CONVERTER PART**

Symbol	Item	Condition	Ratings	Unit
VRRM	Repetitive peak reverse voltage		1600	V
Ea	Recommended AC input voltage		440	Vrms
Io	DC output current	3φ rectifying circuit	12	A
IFSM	Surge (non-repetitive) forward current	1 cycle at 60Hz, peak value non-repetitive	120	A
I²t	I²t for fusing	Value for one cycle of surge current	60	A²s

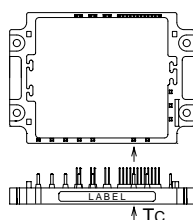
**CONTROL PART**

Symbol	Item	Ratings	Unit
VD, VDB	Supply voltage	-0.5 ~ 20	V
VCIN	Input signal voltage	-0.5 ~ +7.5	V
VFO	Fault output supply voltage	-0.5 ~ +7.5	V
Ifo	Fault output current	15	mA
Iamp	DC-Link IGBT current signal Amp output current	1	mA

**PS12032**
**FLAT-BASE TYPE  
INSULATED TYPE**
**TOTAL SYSTEM**

Symbol	Item	Condition	Ratings	Unit
T <sub>j</sub>	Junction temperature	(Note 2)	-20 ~ +125	°C
T <sub>stg</sub>	Storage temperature	—	-40 ~ +125	°C
T <sub>c</sub>	Module case operating temperature	(Fig. 3)	-20 ~ +100	°C
Viso	Isolation voltage	60 Hz sinusoidal AC applied between all terminals and the base plate for 1 minute.	2500	Vrms
—	Mounting torque	Mounting screw: M3.5	0.78 ~ 1.27	N·m

(Note 2) : The indicated values are specified considering the safe operation of all the parts within the ASIPM. The max. ratings for the ASIPM power chips (IGBT & FWDi) is T<sub>j</sub> < 150.

**CASE TEMPERATURE MEASUREMENT POINT**


(Fig. 3)

**THERMAL RESISTANCE**

Symbol	Item	Condition	Ratings			Unit
			Min.	Typ.	Max.	
Rth(j)cQ	Junction to case Thermal Resistance	Inverter IGBT (1/6)	—	—	2.5	°C/W
Rth(j)cF		Inverter FWDi (1/6)	—	—	4.5	°C/W
Rth(j)cFR		Converter Di (1/6)	—	—	2.5	°C/W
Rth(cf)	Contact Thermal Resistance	Case to fin, thermal grease applied (1 Module)	—	—	0.05	°C/W

**ELECTRICAL CHARACTERISTICS** (T<sub>j</sub> = 25°C, V<sub>D</sub> = 15V, V<sub>DB</sub> = 15V unless otherwise noted)

Symbol	Item	Condition	Ratings			Unit
			Min.	Typ.	Max.	
V <sub>CE(sat)</sub>	Collector-emitter saturation voltage	T <sub>j</sub> = 25°C, Input = ON, I <sub>c</sub> = 5A, V <sub>D</sub> = V <sub>DB</sub> = 15V (Shunt voltage drop not included)	—	—	3.6	V
V <sub>EC</sub>	FWDi forward voltage	T <sub>j</sub> = 25°C, -I <sub>c</sub> = 5A	—	—	3.5	V
V <sub>FR</sub>	Converter diode voltage	T <sub>j</sub> = 25°C, I <sub>FR</sub> = 5A	—	—	1.5	V
I <sub>RRM</sub>	Converter diode reverse current	V <sub>R</sub> = V <sub>RRM</sub> , T <sub>j</sub> = 125°C	—	—	8	mA
ton	Switching times	1/2 Bridge inductive, Input = 5V ↔ 0V V <sub>CC</sub> = 600V, I <sub>c</sub> = 5A, T <sub>j</sub> = 125°C V <sub>D</sub> = 15V, V <sub>DB</sub> = 15V Note: ton, toff include delay time of the internal control circuit.	0.3	1.2	2.0	μs
tc(on)			—	0.5	1.4	μs
toff			—	2.2	4.0	μs
tc(off)			—	0.9	1.6	μs
trr	FWDi reverse recovery time		—	0.2	—	μs
Short circuit endurance (Output, Arm, and Load, Short Circuit Modes)		@V <sub>CC</sub> ≤ 800V, Input = 5V → 0V (One-Shot) -20°C ≤ T <sub>j(start)</sub> ≤ 125°C, 13.5V ≤ V <sub>D</sub> = V <sub>DB</sub> ≤ 16.5V	<ul style="list-style-type: none"> <li>• No destruction</li> <li>• FO output by protection operation</li> </ul>			
Switching SOA		@V <sub>CC</sub> ≤ 800V, Input = 5V ↔ 0V, T <sub>j</sub> ≤ 150°C I <sub>c</sub> < OC trip level, 13.5V ≤ V <sub>D</sub> = V <sub>DB</sub> ≤ 16.5V	<ul style="list-style-type: none"> <li>• No destruction</li> <li>• No protecting operation</li> <li>• No FO output</li> </ul>			

# PS12032

FLAT-BASE TYPE  
INSULATED TYPE

## ELECTRICAL CHARACTERISTICS (Tj = 25°C, Vd = 15V, VDB = 15V unless otherwise noted)

Symbol	Item	Condition	Ratings			Unit
			Min.	Typ.	Max.	
Id	Circuit current	Tj = 25°C, Vd = 15V, Vin = 5V	—	—	50	mA
IdB	Circuit current	Tj = 25°C, Vd = VDB = 15V, Vin = 5V	—	—	5	mA
Vth(on)	Input on threshold voltage		0.8	1.4	2.0	V
Vth(off)	Input off threshold voltage		2.5	3.0	4.0	V
Ri	Input pull-up resistor	Applied between input terminal-Inside power supply	—	50	—	kΩ
fPWM	PWM input frequency	Tc ≤ 100°C, Tj ≤ 125°C	—	10	15	kHz
tdead	Arm shoot-through blocking time	Relates to corresponding inputs Tc = -20°C ~ +100°C (Note 3)	4.0	—	—	μs
tint	Input interlock sensing	Relates to corresponding input (Fig. 6)	—	100	—	ns
Vamp(100%)	Inverter DC-Link IGBT current sense voltage	Ic = IOP(100%) Vd = 15V	1.5	2.0	2.5	V
Vamp(200%)	output signal	Ic = IOP(200%) Tj = 25°C (Fig. 4)	3.0	4.0	5.0	V
Vamp(250%)	Inverter DC-Link IGBT current sense voltage	Ic = IOP(250%) Vd = 15V	5.0	—	—	V
Vamp(0)	output limit	Ic = 0A (Fig. 4)	—	50	100	mV
OC	Over current trip level	Tj = 25°C (Fig. 5)	5.5	7.0	—	A
tOC	Over current delay time	Tj = 25°C (Fig. 5)	—	10	—	μs
SC	Short circuit trip level	Tj = 25°C (Fig. 5)	—	11.0	—	A
tsc	Short circuit delay time	Tj = 25°C (Fig. 5)	—	2	—	μs
UVd	Supply circuit under voltage protection	Vd UV trip level	11.0	12.0	12.75	V
UVDr		Vd UV reset level	11.5	12.5	13.25	V
UVDB		VDB UV trip level	10.1	10.8	11.6	V
UVDBr		VDB UV reset level	10.6	11.3	12.1	V
tdV		UV delay time	Tc = Tj = 25°C	—	10	—
tFO	Fault output pulse width	Tj = 25°C (Note 4)	1.0	1.8	—	ms
IFo(H)	Fault output current	Open drain output (Note 4)	—	—	1	μA
IFo(L)			—	—	15	mA
RTH	Thermistor Resistance	Tc = 25°C	9.5	10	10.5	kΩ
B	Thermistor B constant	Resistance at 25°C, 50°C	—	3450	—	K

(Note 3) : The dead-time has to be set externally by the CPU; it is not part of the ASIPM internal functions.

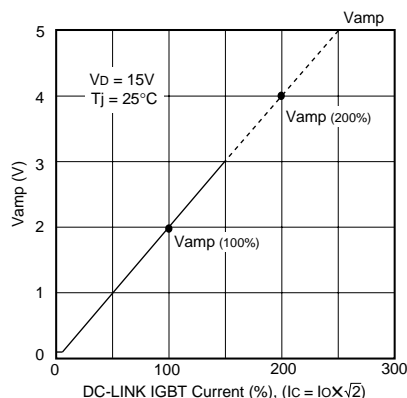
(Note 4) : Fault output signaling is given only when the internal OC, SC, & UV protection circuits are activated.

The OC, SC and UV protection (and fault output) operate for the lower arms only. The OC and SC protection Fault output is given in a pulse format while that of UV protection is maintained throughout the duration of the under-voltage condition.

## RECOMMENDED OPERATING CONDITIONS

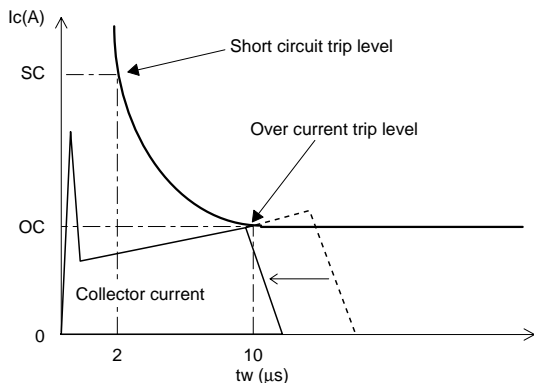
Symbol	Item	Condition	Ratings			Unit
			Min.	Typ.	Max.	
VCC	Supply voltage	Applied across P2-N2 terminals	—	600	800	V
Vd	Supply voltage	Applied between Vd-GND	13.5	15.0	16.5	V
VDB	Supply voltage	Applied between CBU+ & CBU-, CBV+ & CBV-, CBW+ & CBW-	13.5	15.0	16.5	V
ΔVd, VDB	Supply voltage ripple		-1	—	+1	V/μs
VCIN(ON)	Input on voltage	Applied between UP • VP • WP • UN • VN • WN and GND	0	—	0.8	V
VCIN(OFF)	Input off voltage		4.0	—	5.0	V
tdead	Arm shoot-through blocking time	Relates to corresponding inputs	4.0	—	—	μs
Tc	Module case operating temperature		—	—	100	°C
fPWM	PWM Input frequency	Tc ≤ 100°C, Tj ≤ 125°C	—	—	15	kHz
tXX	Allowable input on-pulse width		1	—	—	μs

## INVERTER DC-LINK IGBT CURRENT ANALOGUE SIGNALING OUTPUT (TYPICAL)



(Fig. 4)

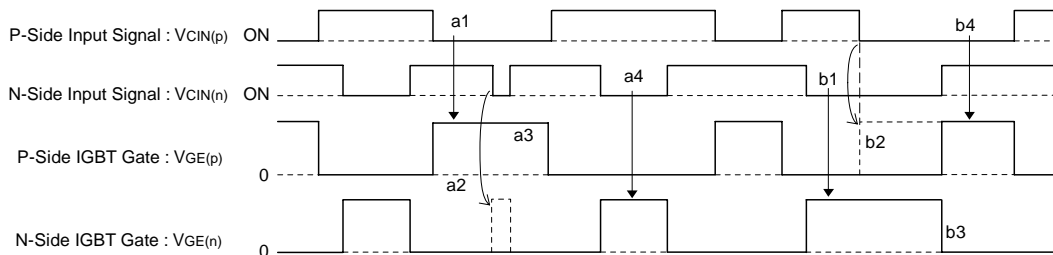
**CURRENT ABNORMALITY PROTECTIVE FUNCTIONS**



(Fig. 5)

Protection is achieved by monitoring and filtering the N-side DC-Bus current. When a current trip-level is exceeded all the N-side IGBTs are intercepted (turned OFF) and a fault-signal is output. After the fault-signal output duration (1.8msec (typ.)@25°C), the interception is Reset at the following OFF input signal level (more than 4.0V).

**ARM-SHOOT-THROUGH INTER-LOCK PROTECTIVE FUNCTION**



(Fig. 6)

**Description:**

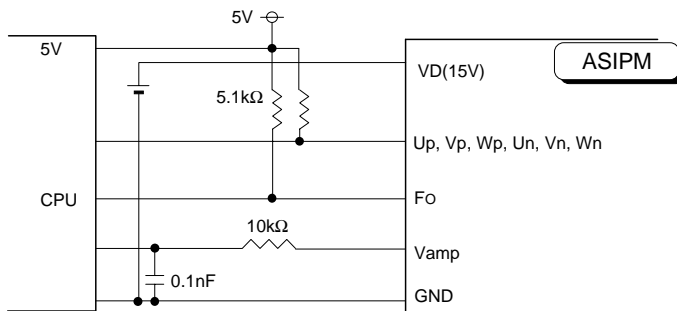
- (1) During the ON-State of either of the upper-arm or the lower-arm IGBT, the inter-lock protection circuit blocks any erroneous ON pulses (resulting from input noise) from triggering the other arm IGBT and thus it prevents the arm-shoot-through situation.
- (2) When two ON-signals are received for both the upper and the lower arms, the signal received first will be passed to the IGBT and the second signal will be blocked. The second signal will be passed to its corresponding IGBT immediately after the first signal is OFF.

**Note:** This protective function provides no fault signaling output. The Dead-Time has to be set using the micro-controller (CPU).

**Operation:**

- a1. P-side normal ON-signal ⇒ P-side IGBT gate turns ON.
- a2. N-side erroneous ON-signal ⇒ N-side IGBT gate remains OFF.
- a3. While P-side ON-signal remains ⇒ P-side IGBT gate remains ON.
- a4. N-side normal ON-signal ⇒ N-side IGBT gate turns ON.
- b1. N-side normal ON-signal ⇒ N-side IGBT gate turns ON.
- b2. Simultaneous ON-signals ⇒ P-side IGBT gate remains OFF.
- b3. N-side receives OFF-signal ⇒ N-side IGBT gate turns OFF.
- b4. Immediately after (b3) ⇒ P-side IGBT gate turns ON.

**RECOMMENDED I/O INTERFACE CIRCUIT**



(Fig. 7)